

MIC2090/1

Current-Limiting Power Distribution Switches

Features

- 1.8V to 5.5V Supply Voltage
- 790 mΩ Typical R_{DS(ON)} at 3.3V
- MIC2090 is Rated for 50 mA Minimum Continuous Current
- MIC2091 is Rated for 100 mA Minimum Continuous Current
- Reverse Current Blocking (OGI)
- 20 ns Super Fast Reaction Time to Hard Short at Output
- 10 ms Fault Flag Delay (t_{D_FAULT}) Eliminates False Assertions
- Auto-Retry Overcurrent and Short-Circuit Protection (-1 Version)
- Latch-Off on Current-Limit (-2 Version)
- Thermal Shutdown
- Fault Status Flag Indicates: Overcurrent, Overtemperature, or UVLO
- Undervoltage Lockout (UVLO)
- Low Quiescent Current

Applications

- USB Peripherals
- Camcorder
- DSC
- MP3/iPod
- SD Protection
- USB Low-Power Hub

General Description

The MIC2090 and MIC2091 are high-side MOSFET power switches optimized for general purpose 50 mA or 100 mA low power distribution in circuits that require overcurrent limiting and circuit protection. Typical applications for these parts include switching power in USB ports, portable consumer items, camera and camcorder motor protection, thermal printer head protection, and many other low current-load switching applications.

The MIC2090 and MIC2091 come in two versions: auto-retry current-limit and output latch off on an overcurrent fault. The MIC2090 and MIC2091 are offered in a space saving 5-pin SOT-23 package with an operating junction temperature range of -40° C to $+125^{\circ}$ C.

Package Type



Typical Application Circuit



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Voltage (V _{IN})	–0.3V to +6.0V
Output Voltage (V _{OUT})	–0.3V to +6.0V
FAULT/ Pin Voltage (V _{FAULT/})	–0.3V to +6.0V
FAULT/ Pin Current (I _{FAULT/})	
EN Pin Voltage (V _{EN})	–0.3V to (V _{IN} + 0.3V)
Power Dissipation (P _D)	Internally Limited
ESD Rating (HBM) (Note 1)	
ESD Rating (MM) (Note 1)	

Operating Ratings ‡

Supply Voltage (V _{IN})+1.8V to +	5.5V
Output Voltage (V _{OUT})+1.8V to +5	5.5V
EN Pin Voltage (V _{EN})0V to	o V _{IN}
FAULT/ Pin Voltage	5.5V
FAULT/ Pin Current	1 mA

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ Notice: The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5 k Ω in series with 100 pF.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: V_{IN} = 5V; T_A = +25°C, **bold** values indicate -40°C ≤ T_A ≤ +85°C, unless noted. Note 1

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions			
Power Input Supply									
Input Voltage Range	V _{IN}	1.8	—	5.5	V	—			
Shutdown Current			5	10		V _{EN} ≤ 0.5V (switch off), V _{OUT} = open			
Supply Current	'VIN		70	110	μΑ	V _{EN} ≥ 1.5V (switch on), V _{OUT} = open			
Undervoltage Lockout Threshold	V _{UVLO}		_	1.75	V	V _{IN} rising			
Undervoltage Lockout Threshold Hysteresis	V _{UVLO_HYS}		100	_	mV	_			
Enable Input									
Enable Logic Level High	V	1.5	—		V	V _{IH(MIN)} , Note 2			
Enable Logic Level Low	VEN		_	0.5	v	V _{IL(MAX)} , Note 2			
Enable Current Bias	I _{EN}		0.1		μA	V _{EN} = 5V			
Output Turn-On Delay	t _{ON}		215	_	μs	$R_L = 500\Omega$, $C_L = 0.1 \mu F$ See Timing Diagrams.			
Output Turn-On Rise Time	t _R	_	5		μs	$R_L = 500\Omega$, $C_L = 0.1 \mu F$ See Timing Diagrams.			
Output Turn-Off Delay	t _{OFF}	_	125	_	μs	$R_L = 500\Omega$, $C_L = 0.1 \mu F$ See Timing Diagrams.			

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $V_{IN} = 5V$; $T_A = +25^{\circ}C$, **bold** values indicate $-40^{\circ}C \le T_A \le +85^{\circ}C$, unless noted. Note 1

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Output Turn-Off Fall Time	t _F	_	115	—	μs	$R_L = 500\Omega$, $C_L = 0.1 \mu F$ See Timing Diagrams.		
Internal Switch								
			700	1200		MIC2090 V _{IN} = 5.0V, I _{OUT} = 50 mA		
		_	790	1200		MIC2090 V _{IN} = 3.3V, I _{OUT} = 50 mA		
On Registeres	Б	_	1300	—		MIC2090 V _{IN} = 1.8V, I _{OUT} = 50 mA		
OII-Resistance	RDS(ON)	_	700	1200	11122	MIC2091 V _{IN} = 5.0V, I _{OUT} = 100 mA		
			790	1200		MIC2091 V _{IN} = 3.3V, I _{OUT} = 100 mA		
			1300			MIC2091 V _{IN} = 1.8V, I _{OUT} = 100 mA		
Input-to-Output Leakage Current (Forward Leakage Current)	_		—	10	μA	MIC2090 and MIC2091, $V_{EN} \le$ 0.5V, (output off), $V_{IN} = 5.5V$, $V_{OUT} = 0V$		
Output-to-Input Leakage Current (Reverse Leakage Current)	_		_	10	μA	MIC2090 and MIC2091, $V_{EN} \le$ 0.5V, (output off), $V_{OUT} =$ 5.5V, $V_{IN} = 0V$		
Current-Limit			_	-	-			
		50	75	100		MIC2090 @ V _{OUT} = 4.5V		
Current-Limit Threshold		50	100	150	mΔ	MIC2090 @ V _{OUT} = 0V		
	LIMIT	100	150	200		MIC2091 @ V _{OUT} = 4.5V		
		100	175	250		MIC2091 @ V _{OUT} = 0V		
Short-Circuit Response Time	t _{SC_RESP}	_	20	_	ns	Short-circuit applied to output after switch is turned on, see Timing Diagrams. $V_{IN} = 3.3V$.		
Time After Switch Shuts Down from an Overcurrent Condition Before It Tries to Turn on Again.	^t auto RESTART	30	60	90	ms	_		
FAULT/ Flag		-			1	1		
Error Flag Output Voltage	—	_	—	0.4	V	Sinking 1 mA		
Time After Switch Comes into Current-Limit before the Pin FAULT/ is Pulled Low.	^t D_FAULT/	5	10	20	ms	When an overcurrent condition happens, the part will go into constant output current for this time. After this time, it will turn off the output and pull low the pin FAULT/. The MIC2090-1 and MIC2091-1 will automatically restart themselves after the auto restart time t _{AUTORESTART} .		
FAULT/ Rising Time	t _{R_FAULT/}	—	5	_	μs	FAULT/ is connected to $V_{IN} = 5V$ through 10 k Ω and 100 pF in parallel. See Timing Diagrams.		
FAULT/ Falling Time	t _{F_FAULT/}	—	1	_	μs	-		
Reverse Voltage Protection (OGI)		1	1	1			
Output Voltage Greater than Input Voltage	OGI	_	85	_	mV	If the output voltage is greater than the input voltage by this amount, the part will shut down. The enable pin must be cycled to reset.		

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: V_{IN} = 5V; T_A = +25°C, **bold** values indicate -40°C ≤ T_A ≤ +85°C, unless noted. Note 1

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
_	OGI _{TIME}		10	_	ms	Time that the output voltage can be greater than the input voltage before the chip is shut down.		
Thermal Protection								
Overtemperature Shutdown	T _{OVER-}	_	150	—	°C	T _J rising		
	TEMP	_	140	_	C	T _J falling		

Note 1: Specification for packaged product only.

2: $V_{IL(MAX)}$ = Maximum positive voltage applied to the input that will be accepted by the device as a logic low. $V_{IH(MIN)}$ = Minimum positive voltage applied to the input that will be accepted by the device as a logic high.

Timing Diagrams



FIGURE 1-1: O

Output Rise and Fall Times (t_R , t_F).



TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Storage Temperature Range	Τ _J	-65		+150	°C	—	
Junction Operating Temperature Range	Τ _J	-40	—	+125	°C	—	
Ambient Operating Temperature Range	Τ _Α	-40	—	+85	°C	—	
Lead Temperature	_	_		+260	°C	Soldering, 5s	
Package Thermal Resistances							
Thermal Resistance SOT-23	θ_{JA}		252.7		°C/W	—	

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



FIGURE 2-1: Input Voltage.



FIGURE 2-2: V_{IN} Supply Current vs. Input Voltage.



FIGURE 2-3: Enable Three Voltage.



FIGURE 2-4: Input Voltage.

MIC2090 Current-Limit vs.



FIGURE 2-5: Input Voltage.

MIC2090 FAULT/ Delay vs.



FIGURE 2-6: MIC2090 Auto-Reset Time vs. Input Voltage.



FIGURE 2-7: MIC2091 Current-Limit vs. Input Voltage.



FIGURE 2-8: Input Voltage.

Switch On-Resistance vs.



FIGURE 2-9:



FIGURE 2-10: Output Rise Time vs. Input Voltage.



FIGURE 2-11: Output Turn-Off Delay vs. Input Voltage.



FIGURE 2-12: Output Fall Time vs. Input Voltage.



FIGURE 2-13: OGI Threshold vs. Input Voltage.



FIGURE 2-14:

OGI Delay vs. Input Voltage.



FIGURE 2-15: Temperature.



FIGURE 2-16: V_{IN} Supply Current vs. Temperature.



FIGURE 2-17: Enable Threshold vs. Temperature.



FIGURE 2-18: Temperature.

MIC2090 Current-Limit vs



FIGURE 2-19: MIC2090 Current-Limit vs. Temperature.



FIGURE 2-20: Temperature.



FIGURE 2-21: MIC2090 Auto-Reset Time vs. Temperature.







FIGURE 2-23: MIC2091 Current-Limit vs. Temperature.



FIGURE 2-24: R_{DS(ON)} vs. Temperature.



FIGURE 2-25: Output Turn-On Delay vs. Temperature.



FIGURE 2-26: (Temperature.



FIGURE 2-27: Output Turn-Off Delay vs. Temperature.



FIGURE 2-28: Output Fall Time vs. Temperature.



FIGURE 2-29: OGI Threshold vs. Temperature.





V_{IN} UVLO Thresholds vs. **FIGURE 2-31:** Temperature.





V_{IN} Turn-On.





UVLO Thresholds. **FIGURE 2-34:**



FIGURE 2-35:

Enable Turn-On/Turn-Off.



Rise Time.



FIGURE 2-37: Enable Turn-Off Delay and Fall Time.



FIGURE 2-38: Current-Limit Response, Enabled into Short.



FIGURE 2-39: Power-Up into Short-Circuit (-1 Version).



FIGURE 2-40: Current-Limit Response, Stepped Short.



FIGURE 2-41: Current-Limit Response, Stepped Overcurrent.



FIGURE 2-42: Output Recovery from Short-Circuit and FAULT/ Response (-1 Version).



FIGURE 2-43: Output Recovery from Thermal Shutdown and FAULT/ Response.



FIGURE 2-44: I_{OUT} Current Limiting for $V_{OUT} < 1.8V$ (-1 Version).



FIGURE 2-45: I_{OUT} Current Limiting for $V_{OUT} > 1.8V$ (-1 Version).



FIGURE 2-46: Inrush

Inrush Current Response.



FIGURE 2-47: $V_{OUT} < V_{IN}$, Enable into Pre-Biased Output.



FIGURE 2-48: $V_{OUT} > V_{IN}$, Enable into Pre-Biased Output.



FIGURE 2-49: $V_{OUT} > V_{IN}$, V_{IN} Turn-On into Pre-Biased Output.



FIGURE 2-50: Increase V_{OUT} Above V_{IN} While Running.



FIGURE 2-51: Overcurrent Latch-Off and Recovery (-2 Version).

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

Pin Number	Pin Name	Description
1	VIN	Supply (Input): +1.8V to +5.5V. Provides power to the output switch and the MIC2090/MIC2091 internal control circuitry.
2	GND	Ground.
3	EN	Enable (Input): Active-high TTL compatible control input. A high signal turns on the internal switch and supplies power to the load. This pin cannot be left floating.
4	FAULT/	 Fault Status (Output): Open-drain output. Can be connected to other open-drain outputs. Must be pulled high with an external resistor. When EN = 0, FAULT/ pin is high When EN = 1, a low on the FAULT/ pin indicates one or more of the following conditions: 1. The part is in current limit and is turned off. 2. The part is in thermal limit and is turned off. 3. The part is in UVLO
5	VOUT	Switched Output (Output): The voltage on this pin is controlled by the internal switch. Connect the load driven by the MIC2090/MIC2091 to this pin.

4.0 FUNCTIONAL DESCRIPTION

4.1 V_{IN} and V_{OUT}

 V_{IN} is both the power supply connection for the internal circuitry driving the switch and the input (source connection) of the power MOSFET switch. V_{OUT} is the drain connection of the power MOSFET and supplies power to the load. In a typical circuit, current flows from V_{IN} to V_{OUT} toward the load.

When the switch is disabled, current will not flow to the load, except for a small unavoidable leakage current of a few microamps (forward leakage current).

4.2 C_{IN}

A minimum 1 μ F bypass capacitor positioned close to the V_{IN} and GND pins of the switch is both good design practice and required for proper operation of the switch. This will control supply transients and ringing. Without a sufficient bypass capacitor, large current surges or a short may cause sufficient ringing on V_{IN} (from supply lead inductance) to cause erratic operation of the switch's control circuitry. For best performance, place a ceramic capacitor next to the IC.

An additional 10 μ F (or greater) capacitor, positioned close to the V_{IN} and GND pins of the switch is necessary if the distance between a larger bulk capacitor and the switch is greater than three inches. This additional capacitor limits input voltage transients at the switch caused by fast changing input currents that occur during a fault condition, such as current limit and thermal shutdown.

When bypassing with capacitors of 10 μ F or more, it is good practice to place a smaller value capacitor in parallel with the larger to handle the high-frequency components of any line transients. Values in the range of 0.1 μ F to 1 μ F are recommended. Again, good quality, low-ESR capacitors, preferably ceramic, should be chosen.

4.3 C_{OUT}

An output capacitor is required to reduce ringing and voltage sag on the output during a transient condition. A value between 1 μ F and 10 μ F is recommended.

A 10 μ F or larger capacitor should be used if the distance between the MIC2090/MIC2091 and the load is greater than three inches. The internal switch in the MIC2090/MIC2091 turns off in (typically) 20 ns. This extremely fast turn-off can cause an inductive spike in the output voltage when the internal switch turns off during an overcurrent condition. The larger value capacitor prevents the output from glitching too low.

4.4 Limitations on C_{OUT}

The part may enter current limit when turning on with a large output capacitance, which is an acceptable condition. However, if the part remains in current limit for a time greater than $t_{D_{FAULT}}$, the FAULT/ pin will assert low. The maximum value of C_{OUT} may be approximated by Equation 4-1.

EQUATION 4-1:

$$\begin{split} C_{OUT(MAX)} &= \frac{I_{LIMIT(MIN)} \times t_{D_FAULT(MIN)}}{V_{IN(MAX)}} \end{split}$$

 Where:
 I_LIMIT(MIN) = The minimum specified value in the Electrical Characteristics table.
 t_D_FAULT(MIN) = The minimum specified value in the Electrical Characteristics table.
 V_IN(MAX) = The maximum input voltage to the switch.

4.5 Current Sensing and Limiting

The MIC2090/MIC2091 protects the system power supply and load from damage by continuously monitoring current through the on-chip power MOSFET. Load current is monitored by means of a current mirror in parallel with the power MOSFET switch. Current limiting is invoked when the load exceeds the overcurrent threshold. When current limiting is activated in the -1 version, the output current is constrained to the limit value, and remains at this level until either the load/fault is removed, the load's current requirement drops below the limiting value, or the switch goes into thermal shutdown. If the overcurrent fault is large enough to drop VOUT below (typically) 1.8V, the internal MOSFET turns off very quickly (typically 20 ns). This prevents excessive current from flowing through the device and damaging the internal MOSFET.

The latch-off feature of the -2 version latches the output off when the output current exceeds the overcurrent threshold. $V_{\rm IN}$ or the enable pin must be toggled to reset the latch.

4.6 Enable Input

The EN pin is a TTL logic level compatible input that turns the internal MOSFET switch on and off. The FAULT/ pin remains high when the EN pin is pulled low and the output is turned off. Toggling the enable pin resets the output after an OGI (output greater than input) condition occurs. In the -2 version, toggling the enable pin resets the output after an overcurrent event.

4.7 Fault/Output

The FAULT/ is an N-channel open-drain output that is asserted LOW when the MIC2090/MIC2091 switch either begins current-limiting or enters thermal shutdown.

During an overcurrent or short-circuit event, the FAULT/ signal asserts after a brief delay period, $t_{D_{FAULT/}}$, in order to filter out false or transient overcurrent conditions.

The FAULT/ output is open-drain and must be pulled high with an external resistor. The FAULT/ signal may be wire-OR'd with other similar outputs, sharing a single pull-up resistor.

4.8 Power Dissipation and Thermal Shutdown

Thermal shutdown is used to protect the MIC2090/MIC2091 switch from damage should the die temperature exceed a safe operating temperature. Thermal shutdown shuts off the output MOSFET and asserts the FAULT/ output if the die temperature reaches the overtemperature threshold, $T_{OVERTEMP}$.

The switch will automatically resume operation when the die temperature cools down to 140°C. If resumed operation results in reheating of the die, another shutdown cycle will occur and the switch will continue cycling between ON and OFF states until the reason for the overcurrent condition has been resolved.

Depending upon the PCB layout, package type, ambient temperature, etc., hundreds of milliseconds may elapse from the time a fault occurs to the time the output MOSFET will be shut off. This delay is caused because of the time it takes for the die to heat after the fault condition occurs.

Power dissipation depends on several factors such as the load, PCB layout, ambient temperature, and supply voltage. Calculation of power dissipation can be accomplished by Equation 4-2.

EQUATION 4-2:

$$P_D = R_{DS(ON)} \times I_{OUT}^{2}$$

To relate this to junction temperature, Equation 4-3 can be used.

EQUATION 4-3:

 $T_J = P_D \times R_{\theta(JA)} + T_A$

Where:

 $\begin{array}{l} \mathsf{T}_{\mathsf{J}} = \mathsf{Junction \ temperature.} \\ \mathsf{T}_{\mathsf{A}} = \mathsf{Ambient \ temperature.} \\ \mathsf{R}_{\theta(\mathsf{JA})} = \mathsf{Thermal \ resistance \ of \ the \ package.} \end{array}$

In normal operation, excessive switch heating is most often caused by an output short-circuit. If the output is shorted, when the switch is enabled, the MIC2090/MIC2091 switch limits the output current to the maximum value. The heat generated by the power dissipation of the switch continuously limiting the current may exceed the package and PCB's ability to cool the device and the MIC2090/MIC2091 will shut down and signal a fault condition. Please see the "Fault Output" description for more details on the FAULT/ output.

After the MIC2090/MIC2091 shuts down, and cools, it will re-start itself if the enable signal remains true.

In Figure 4-1, die temperature is plotted against I_{OUT} assuming a constant ambient temperature of +85°C and a worst case internal switch on-resistance (R_{ON}). This plot is valid for both the MIC2090 and MIC2091.



FIGURE 4-1: Die Temperature vs. I_{OUT}.

4.9 I_{LIMIT} vs. I_{OUT} Measured (-1 Version Only)

When the MIC2090/MIC2091 is current-limiting, it is designed to act as a constant current source to the load. As the load tries to pull more than the maximum current, V_{OUT} drops and the input to output voltage differential increases. When V_{OUT} drops below 1.8V, the output switch momentarily turns off to ensure the internal MOSFET switch is not damaged by a very fast short-circuit event.

When measuring I_{OUT} in an overcurrent condition, it is important to remember voltage dependence, otherwise the measurement data may appear to indicate a problem when one does not really exist. This voltage dependence is illustrated in Figure 4-2 and Figure 4-3.

In Figure 4-2, output current is measured as V_{OUT} is pulled below V_{IN}, with the test terminating when V_{OUT} is 2.5V below V_{IN}. Observe that once I_{LIMIT} is reached, I_{OUT} remains constant throughout the remainder of the test.

Figure 4-3 repeats this test, but simulates operation deeper into an overcurrent condition. When V_{OUT} drops below 1.8V, the switch turns off for a few microseconds before turning back on.



V_{OUT} > 1.8V.



FIGURE 4-3: I_{OUT} in Current-Limiting for $V_{OUT} < 1.8V$.

4.10 Undervoltage Lockout (UVLO)

The MIC2090/MIC2091 switches have an Undervoltage Lockout (UVLO) feature that will shut down the switch in a reproducible way when the input power supply voltage goes too low. The UVLO circuit disables the output until the supply voltage exceeds the UVLO threshold. Hysteresis in the UVLO circuit prevents noise and finite circuit impedance from causing chatter during turn-on and turn-off. While disable by the UVLO circuit, the output switch (power MOSFET) is OFF and no circuit functions, such as FAULT/ or EN, are considered to be valid or operative.

4.11 Output Greater than Input (OGI)

The internal MOSFET switch turns off when it senses an output voltage that is greater than the input voltage. This feature prevents continuous current from flowing from the output to the input.

If the output voltage rises above $V_{\rm IN}$ by the OGI threshold voltage (typically 85 mV), the internal MOSFET switch turns off after a period of time,

specified in the Electrical Characteristics table as OGI_{TIME}. The FAULT/ pin remains high during and after an OGI event.

Figure 4-4 shows the output voltage, input current, and FAULT/ pin voltage when the output voltage is raised above the input. Reverse current flows through the internal MOSFET switch for the OGI_{TIME} period, until the internal MOSFET switch is turned off and the input current goes to 0A.



5.0 PACKAGING INFORMATION

5.1 Package Marking Information



Part Number	Marking
MIC2090-1YM5-TR	<u>L1</u> K
MIC2090-2YM5-TR	<u>L2</u> K
MIC2091-1YM5-TR	<u>M1</u> K
MIC2091-2YM5-TR	<u>M2</u> K



5-Lead SOT-23 Package Outline and Recommended Land Pattern

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (November 2021)

- Converted Micrel document MIC2090/1 to Microchip data sheet DS20006611A.
- Minor text changes throughout.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

					Example	es:	
Device Part No.	-<u>X</u> Current-Lim Recovery	<u>X</u> it Junction Temp. Range	<u>XX</u> Package	- <u>XX</u> Media Type	a) MIC20	90-1YM5-TR:	MIC2090, Auto-Retry Current- Limit Recovery, –40°C to +125°C Temp. Range, 5-Lead SOT-23, 3,000/Reel
Device: Current-Limit	MIC2090	/MIC2091:Current-L Switches Auto-Retry	imiting Power [Distribution	b) MIC20	90-2YM5-TR:	MIC2090, Latch-Off Current- Limit Recovery, –40°C to +125°C Temp. Range, 5-Lead SOT-23, 3,000/Reel
Recovery: Junction Temperature	2 = Y =	Latch-Off			c) MIC20	91-1YM5-TR:	MIC2091, Auto-Retry Current- Limit Recovery, –40°C to +125°C Temp. Range, 5-Lead SOT-23, 3,000/Reel
Range: Package:	M5 =	5-Lead SOT-23			d) MIC20	91-2YM5-TR:	MIC2091, Latch-Off Current- Limit Recovery, –40°C to +125°C Temp. Range, 5-Lead SOT-23, 3,000/Reel
Media Type:	TR =	3,000/Reel			Note 1:	Tape and Reel i catalog part nun used for orderin the device pack Sales Office for Tape and Reel of	dentifier only appears in the nber description. This identifier is g purposes and is not printed on age. Check with your Microchip package availability with the option.

NOTES:

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